Kingbright

5.0mm x 6.0mm SURFACE MOUNT LED LAMP

PRELIMINARY SPEC

Part Number: AAAF5060BESUVGAC

BLUE
HYPER RED
GREEN



ATTENTION
OBSERVE PRECAUTIONS
FOR HANDLING
ELECTROSTATIC
DISCHARGE
SENSITIVE
DEVICES

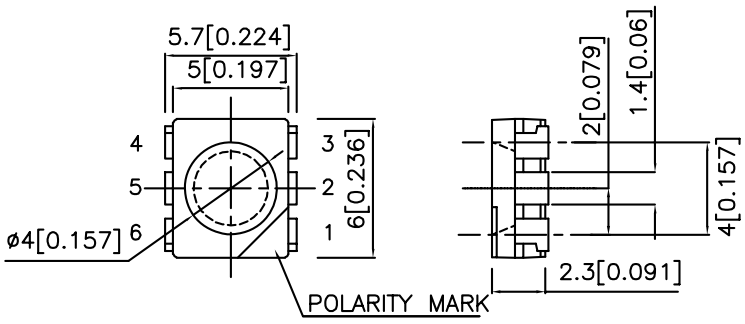
Features

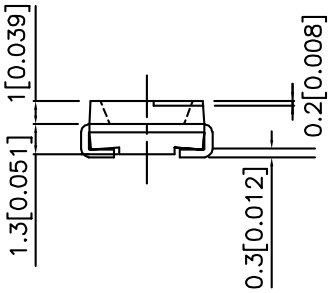
- ●CHIPS CAN BE CONTROLLED SEPARATELY.
- ●SUITABLE FOR ALL SMT ASSEMBLY AND SOLDER PROCESS.
- ●AVAILABLE ON TAPE AND REEL.
- ●PACKAGE: 500PCS / REEL.
- ●MOISTURE SENSITIVITY LEVEL : LEVEL 4.
- ●RoHS COMPLIANT.

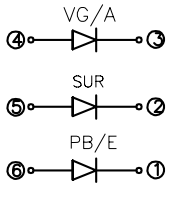
Description

The Blue source color devices are made with InGaN on SiC Light Emitting Diode.
The Hyper Red source color devices are made with DH InGaAlP on GaAs substrate Light Emitting Diode.
The Green source color devices are made with InGaN on G-SiC Light Emitting Diode.
Static electricity and surge damage the LEDS.
It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs.
All devices, equipment and machinery must be electrically grounded.

Package Dimensions







Notes:
1. All dimensions are in millimeters (inches).
2. Tolerance is ±0.25(0.01") unless otherwise noted.
3. Specifications are subject to change without notice.

Selection Guide

Part No.	Dice	Lens Type	Iv (mcd) [2] @30mA *50mA		Viewing Angle [1]
			Min.	Typ.	2 θ 1/2
AAAF5060BESUVGAC	BLUE (InGaN)	WATER CLEAR	110	250	100°
	HYPER RED (InGaAlP)		*380	*500	
	GREEN (InGaN)		180	350	

Notes:
1. θ1/2 is the angle from optical centerline where the luminous intensity is 1/2 the optical centerline value.
2. *Luminous intensity with asterisk is measured at 50mA; Luminous intensity / luminous flux: +/-15%.

Electrical / Optical Characteristics at T_A=25°C

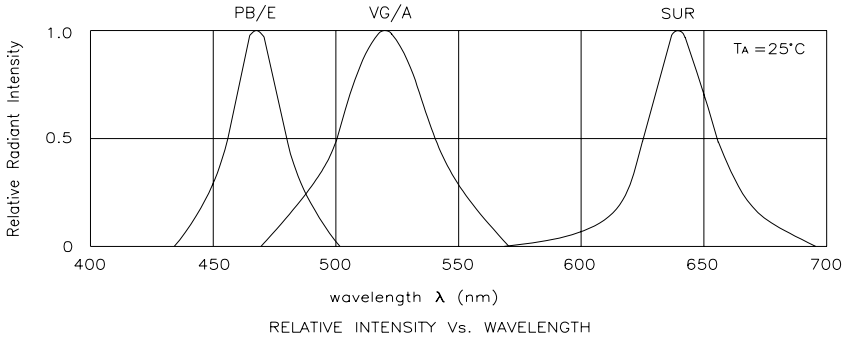
Symbol	Parameter	Device	Typ.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Blue Hyper Red Green	465 640 520		nm	I_F=20mA
λD [1]	Dominant Wavelength	Blue Hyper Red Green	470 628 525		nm	I_F=20mA
Δλ1/2	Spectral Line Half-width	Blue Hyper Red Green	25 27 35		nm	I_F=20mA
C	Capacitance	Blue Hyper Red Green	110 45 100		pF	V_F=0V;f=1MHz
V_F [2]	Forward Voltage	Blue Hyper Red Green	3.7 1.9 3.2	4.3 2.5 4.0	V	I_F=20mA
I_R	Reverse Current	Blue Hyper Red Green		10 10 10	uA	V_R = 5V

Notes:
1.Wavelength: +/-1nm.
2. Forward Voltage: +/-0.1V.

Absolute Maximum Ratings at T_A=25°C

Parameter	Blue	Hyper Red	Green	Units
Power dissipation [2]	350			mW
DC Forward Current	30	50	50	mA
Peak Forward Current [1]	160	185	100	mA
Reverse Voltage	5	5	5	V
Operating / Storage Temperature	-40°C To +85°C			

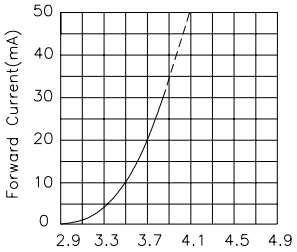
Notes:
1. 1/10 Duty Cycle, 0.1ms Pulse Width.
2. Within 350mW at all chips are lightened.



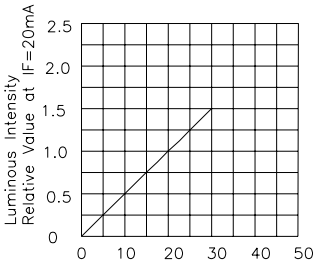
RELATIVE INTENSITY Vs. WAVELENGTH

AAAF5060BESUVGAC

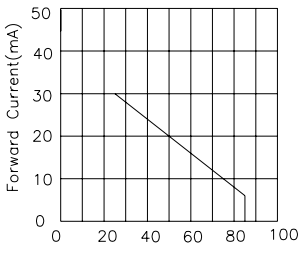
Blue



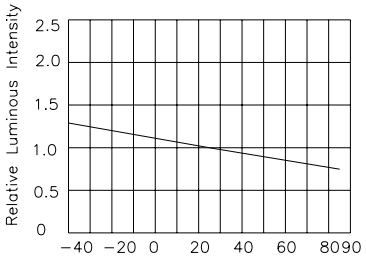
FORWARD CURRENT Vs.
FORWARD VOLTAGE



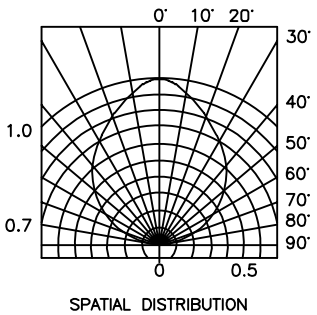
LUMINOUS INTENSITY Vs.
FORWARD CURRENT



FORWARD CURRENT
DERATING CURVE

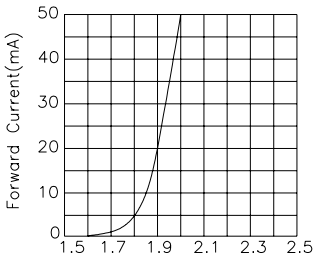


LUMINOUS INTENSITY Vs.
AMBIENT TEMPERATURE

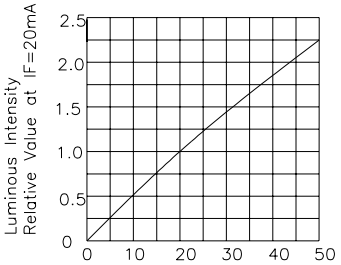


SPATIAL DISTRIBUTION

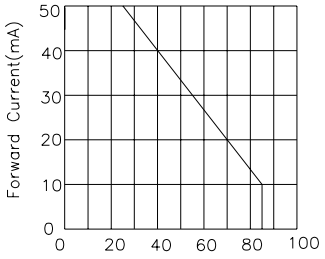
Hyper Red



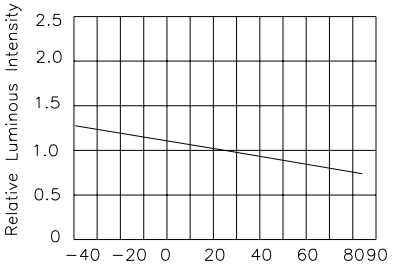
FORWARD CURRENT Vs.
FORWARD VOLTAGE



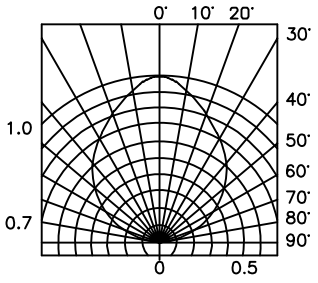
LUMINOUS INTENSITY Vs.
FORWARD CURRENT



FORWARD CURRENT
DERATING CURVE

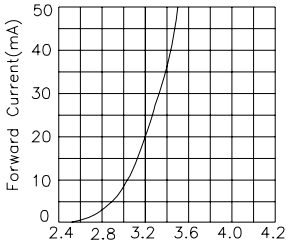


LUMINOUS INTENSITY Vs.
AMBIENT TEMPERATURE

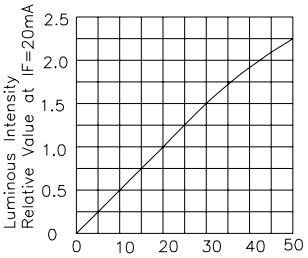


SPATIAL DISTRIBUTION

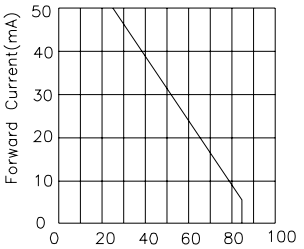
Green



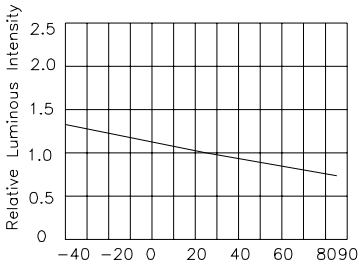
Forward Voltage(V)
FORWARD CURRENT Vs
FORWARD VOLTAGE



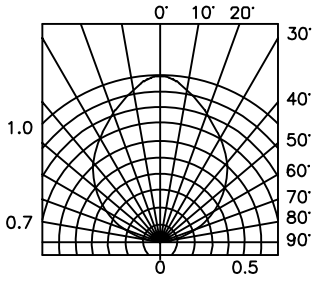
IF–Forward Current (mA)
LUMINOUS INTENSITY Vs.
FORWARD CURRENT



Ambient Temperature TA (°C)
FORWARD CURRENT
DERATING CURVE



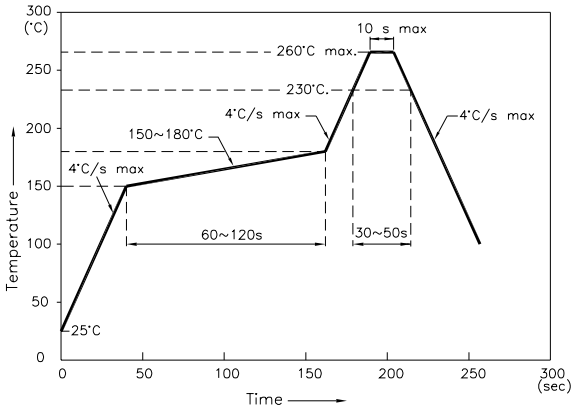
Ambient Temperature TA (°C)
LUMINOUS INTENSITY Vs.
AMBIENT TEMPERATURE



SPATIAL DISTRIBUTION

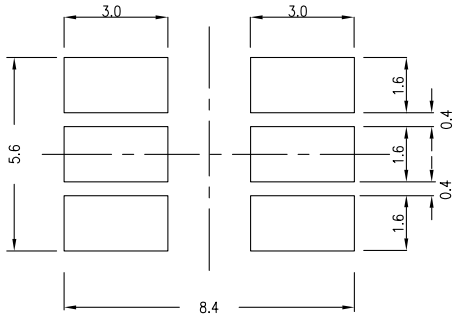
AAAF5060BESUVGAC

Reflow Soldering Profile For Lead-free SMT Process.

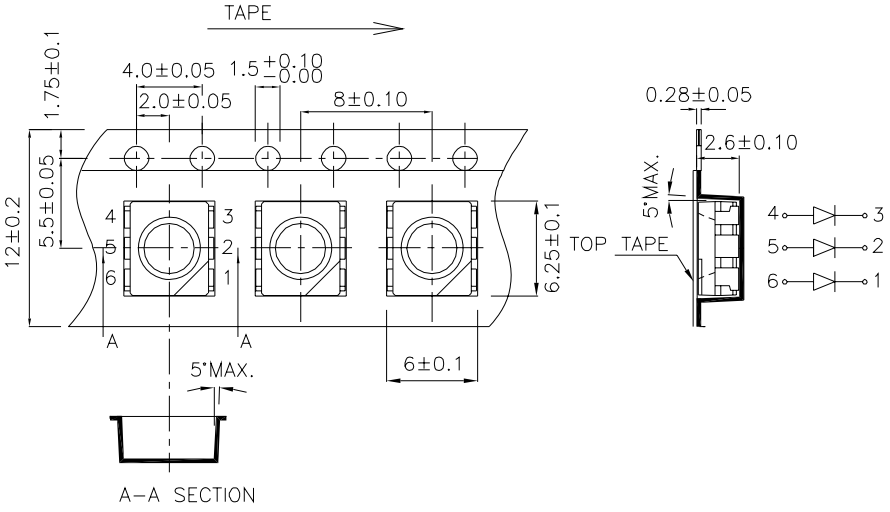


NOTES:
1. We recommend the reflow temperature 245°C(+/-5°C).The maximum soldering temperature should be limited to 260°C.
2. Don't cause stress to the epoxy resin while it is exposed to high temperature.
3. Number of reflow process shall be 2 times or less.

Recommended Soldering Pattern
(Units : mm; Tolerance: ± 0.1)



Tape Specifications
(Units : mm)



Kingbright

PACKING & LABEL SPECIFICATIONS **AAAF5060BESUVGAC**

